

# WP10 – CSIC report



VNIVERSITAT  
ID VALÈNCIA



**CSIC**  
CONSEJO SUPERIOR DE INVESTIGACIONES CIENTÍFICAS

Carlos Marinas, Marcel Vos (IFIC – UVEG/CSIC – Valencia),

2nd<sup>t</sup> AIDAinnova annual meeting, Valencia, April 2023



This project has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement No 101004761.

- detector R&D embedded in the global R&D landscape

## Future Projects Timeline

Agreed Working Hypothesis



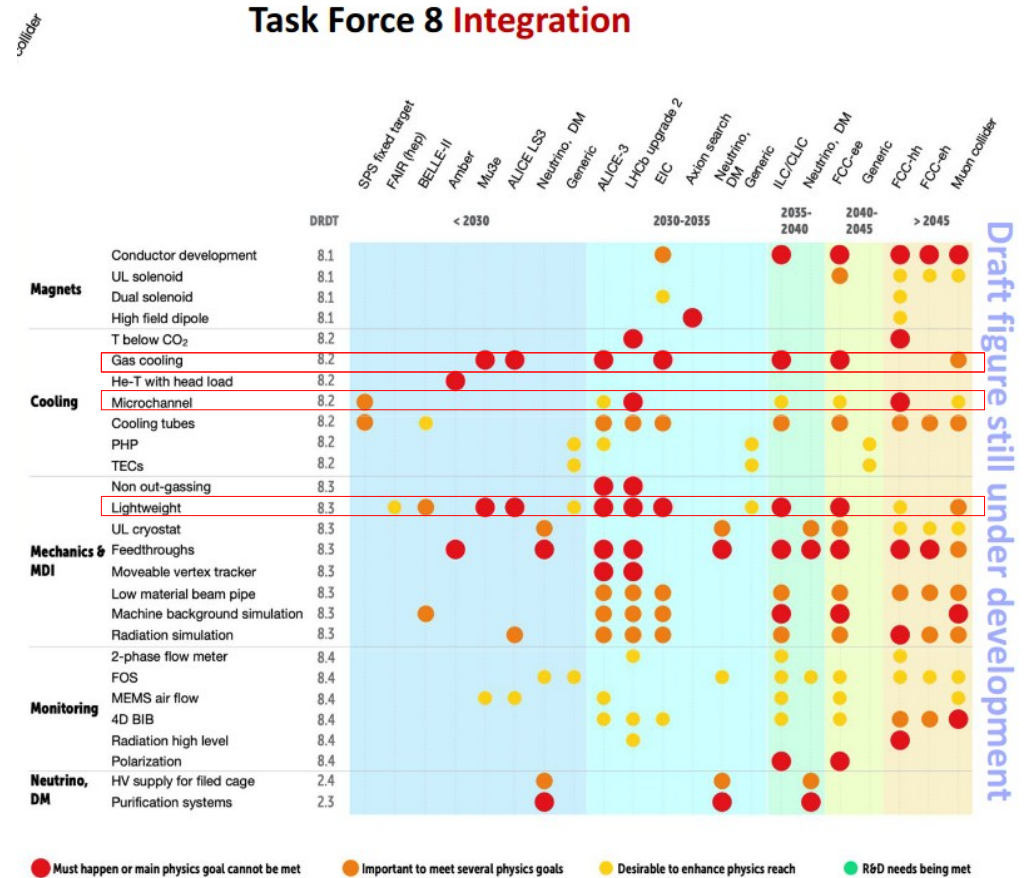
Belle II upgrade (circa 2027):  
<https://arxiv.org/pdf/2203.11349.pdf>

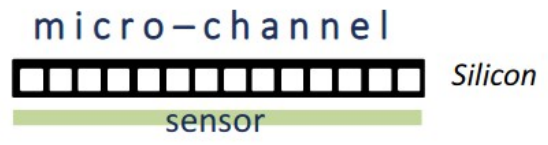
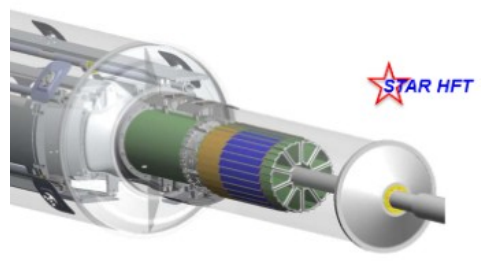
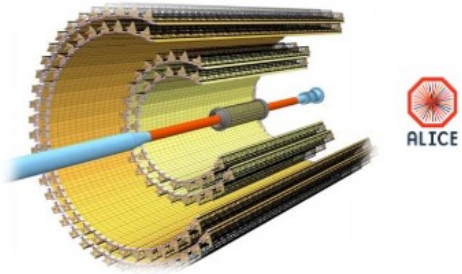
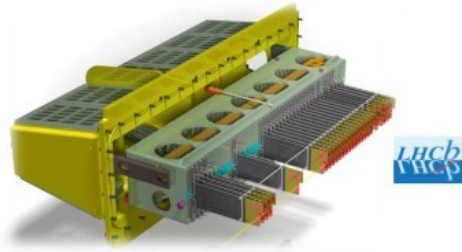
- Funding for “future” projects and “blue sky” R&D is scarce
- Try to use intermediate-timescale projects as stepping stones

Important effort in Europe to inventorize detector R&D needs of upcoming experiments in particle physics

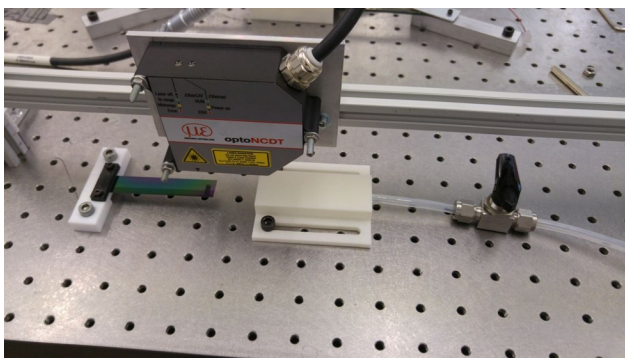
See also:  
Snowmass detector R&D

See talks in ECFA R&D symposium:  
<https://indico.cern.ch/event/999825/>

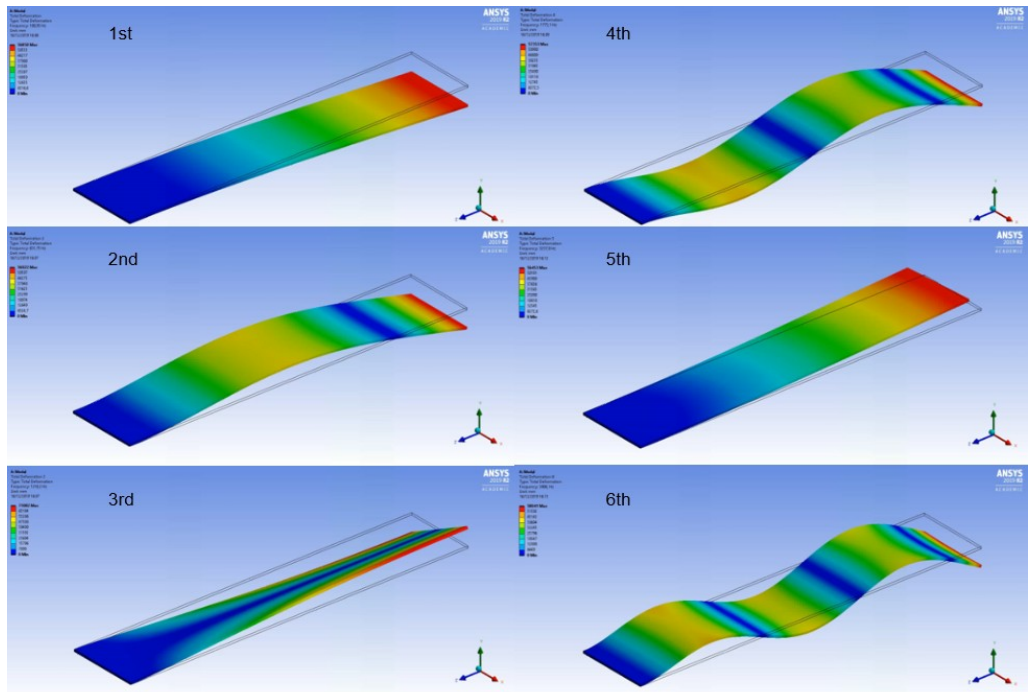
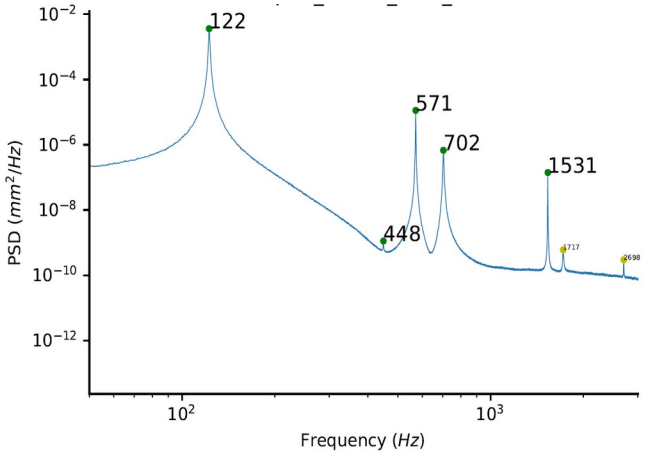


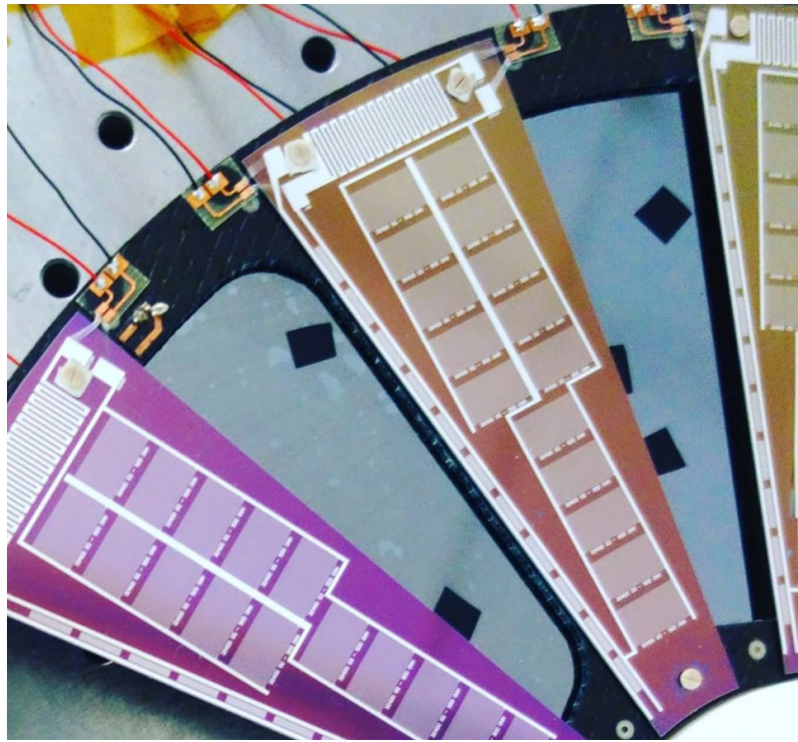


Multiple silicon structures measured in Oxford and Valencia



Vibration Setup – IFIC Valencia





Master's thesis Yamal Naser Requena

Analytical expressions

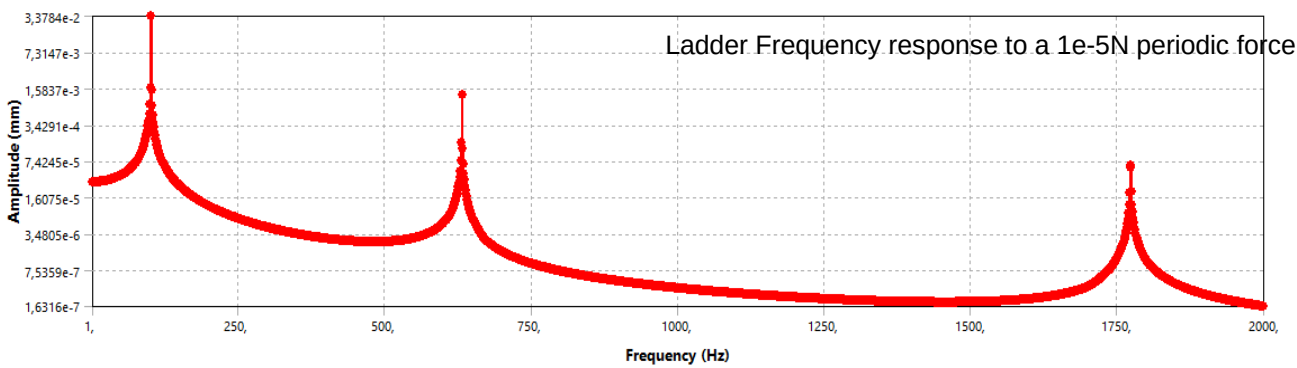
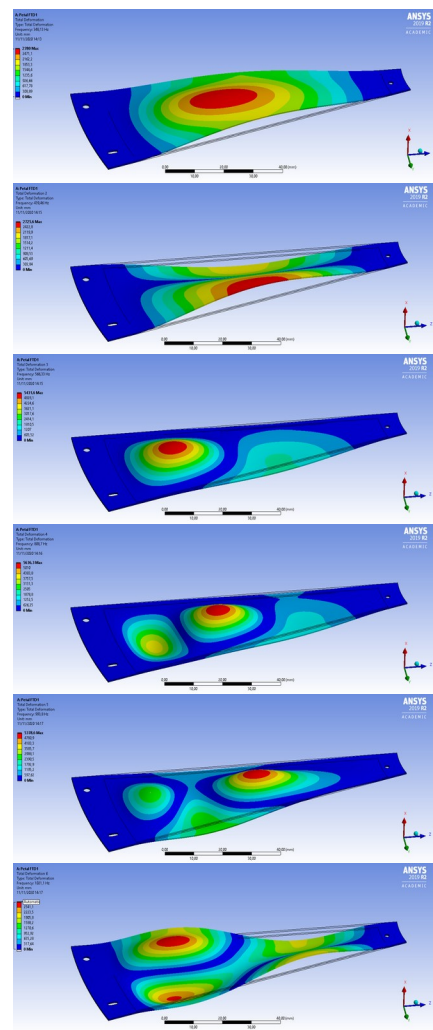
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ANSYS FEA

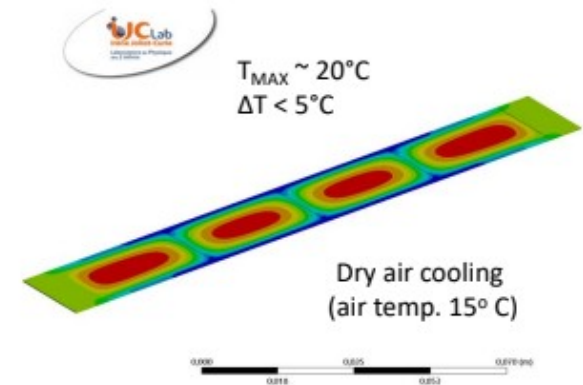
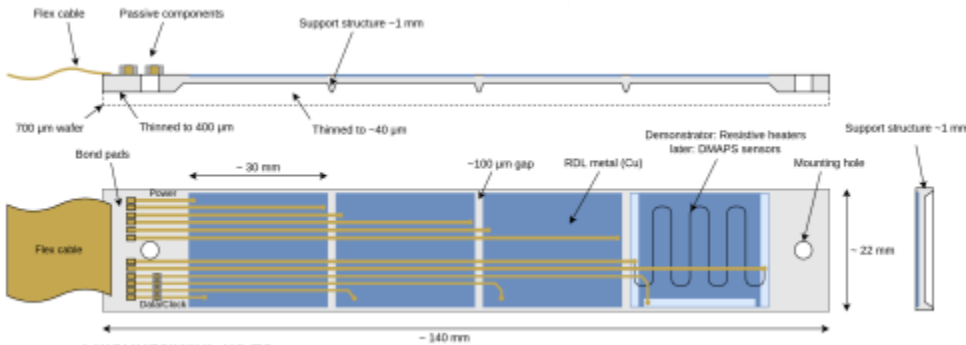
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Measurements

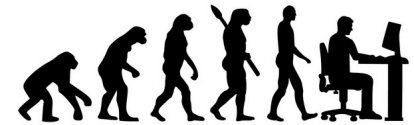
Extend to more realistic vibration loads (air flow, cavern floor, earthquake)



Thin multi-CMOS-chip Silicon structures for Belle 2 upgrade  
 Thermo-mechanical iVTX demonstrator submitted to IZM by  
 Bonn/Valencia, thermal simulations in IJCLab Paris  
 part of Belle 2 upgrade CDR



# MCC evolution: integrated cooling



Hybrid pixel detector &  
micro-channel cooling plate



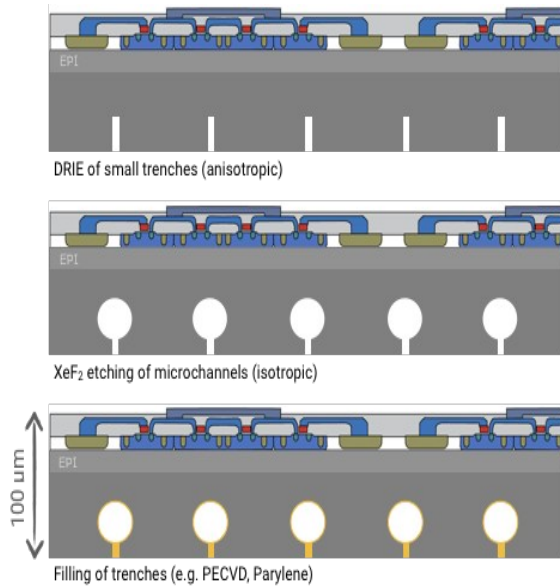
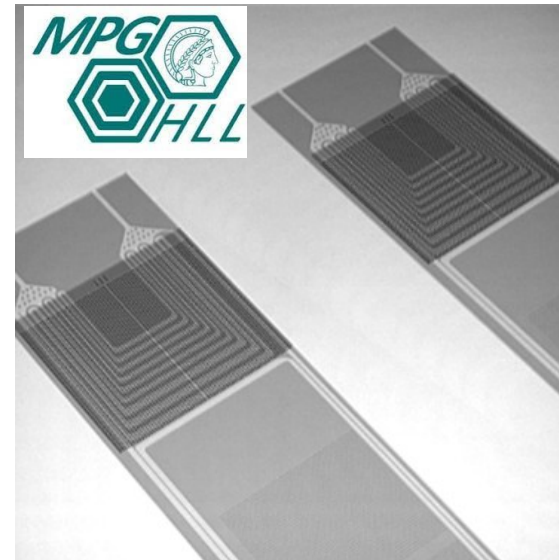
Monolithic CMOS detector



Monolithic CMOS detector  
with integrated micro-channels



- 2016: Developed process to integrate micro-channels in DEPFET Silicon sensor (with MPG-HLL, JINST11(2016) 06)



M. Boscardin et al., NIM A, 2013  
 C. Lipp, MSc Thesis, EPFL, 2017  
 I. Berdalovic et al., JINST 13 C01023, 2018

2019: Buried micro-channels in working MALTA CMOS sensor (CERN, EPFL)



Grant Agreement No: 101004761

## AIDAInnova

Advancement and Innovation for Detectors at Accelerators  
Horizon 2020 Research Infrastructures project AIDAINNOVA

### MILESTONE REPORT

## COMBINED WORKPLAN WITH OBJECTIVES AND TEST DEFINITION FOR ALL TECHNOLOGIES

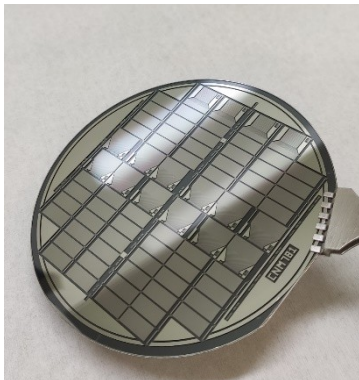
### MILESTONE: MS41

Document identifier:	AIDAInnova_MS41.docx
Due date of milestone:	End of Month 11 (February 2022)
Justification for delay:	[if delays occurred]
Report release date:	07/03/2022
Work package:	WP10: Advanced mechanics for tracking and vertex detectors
Lead beneficiary:	CERN
Document status:	Draft

## Milestone MS41 with minor delay

### Executive summary:

- CNM anodic/eutectic bonding (see M. Ullan)
- HLL direct bonding (see L. Andricek)
- INFN effort on CoolFPGA (see L. Bosi)
- buried channels currently uncovered



**Aim: integrate support structures and micro-channel cooling in “large” CMOS ladders for Belle 2 upgrade and Higgs factories**

**Development of low-temperature bonding compatible with CMOS post-processing ongoing at CNM and HLL (see talks by L. Andricek and M. Ullan)**

**IFIC to focus on simulation studies and design and characterization of prototypes (hiring a new student or engineer towards the end of AIDAinnova)**

**Small steps: mechanical prototypes & dummy CMOS wafers within AIDAinnova, full demonstrator beyond the timeline of the project.**